F98 Series Resin-Molded Chip, High CV Undertab





CASE DIMENSIONS: millimeters (inches)

FEATURES

- Compliant to the RoHS2 directive 2011/65/EU
- SMD face down design
- Small and low profile

APPLICATIONS

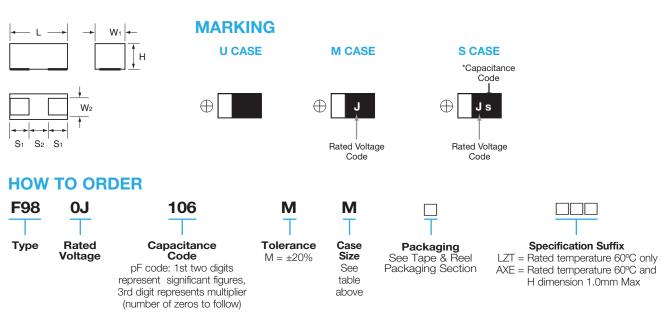
- Smartphone
- Mobile phone
- Wireless module
- Hearing aid





Code EIA Code EIA Metric W₁ L W_2 н S₁ S_2 **1.60** +0.20 -0.10 0.85 +0.20 0.65±0.10 0.80±0.10*3 0.50±0.10 0.60±0.10 Μ 0603 1608-09 (0.063 +0.008) (0.033 +0.008) (0.026 ± 0.004) (0.031 ± 0.004) (0.020 ± 0.004) (0.024 ± 0.004) 2.00 +0.20 1.25 +0.20 -0.10 0.90±0.10 0.80±0.10 0.50±0.10 1.00±0.10 s 0805 2012-09 (0.079 +0.008) (0.049 +0.008) (0.035±0.004) (0.031 ± 0.004) (0.020±0.004) (0.039±0.004) 1.10±0.05 0.60 ± 0.05 0.35 ± 0.05 0.55±0.05 0.30 ± 0.05 0.50 ± 0.05 U 0402 1106-06 (0.043±0.002) (0.024 ± 0.002) (0.014 ± 0.002) (0.022 ± 0.002) (0.012 ± 0.002) (0.020 ± 0.002)

*3 F980J107MMAAXE: 1.0mm Max.



TECHNICAL SPECIFICATIONS

urrent at 85°C
urrent at 125°C





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CAPACITANCE AND RATED VOLTAGE RANGE (LETTER DENOTES CASE SIZE)

Capac	citance	Rated Voltage						*Cap		
μF	Code	2.5 (0e)	4V (0G)	6.3V (0J)	10V (1A)	16V (1C)	20V (1D)	25V (1E)	35V (1V)	Code
0.47	474					U				N
1.0	105					М	М	М	S	A
2.2	225				M/U	М				J
4.7	475		U	M/U	M/U**	М				S
10	106		U	M/U**	М	S				а
15	156		U							е
22	226		M/U**	M	M**/S					J
33	336		М	M	M**/S					n
47	476	М	М	S	S					S
68	686		M/S							W
100	107		M/S	M*4/S						A
220	227		S							J

Released ratings

*4 Rated temperature 60°C and H dimension 1.0mm Max only. Please contact AVX when you need detail spec.

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RATINGS & PART NUMBER REFERENCE

AVX Part No.	Case Size	Capacitance (µF)	Rated Voltage (V)	*2 DCL (μA)	DF @ 120Hz (%)	ESR @ 100kHz (Ω)	*1 ∆C/C (%)	MSL
2.5 Volt								
F980E476MMA	М	47	2.5	1.2	30	4	±30	3
4 Volt								
F980G475MUA	U	4.7	4	0.5	20	20	±30	3
F980G106MUA	U	10	4	0.8	25	20	±30	3
F980G156MUA	U	15	4	9.0	40	25	±30	3
F980G226MMA	Μ	22	4	0.9	15	7.5	±30	3
F980G226MUALZT	U	22	4	25.0	40	20	±30	3
F980G336MMA	Μ	33	4	1.3	30	4	±30	3
F980G476MMA	М	47	4	1.9	40	8	±30	3
F980G686MMA	Μ	68	4	27.2	50	10	±30	3
F980G686MSA	S	68	4	2.7	30	4	±30	3
F980G107MMA	Μ	100	4	80.0	60	10	±30	3
F980G107MSA	S	100	4	4.0	35	4	±30	3
F980G227MSA	S	220	4	132	80	5	±30	3
6.3 Volt								
F980J475MMA	М	4.7	6.3	0.5	20	7.5	±30	3
F980J475MUA	U	4.7	6.3	0.6	20	20	±30	3
F980J106MMA	М	10	6.3	0.6	8	6	±30	3
F980J106MUALZT	U	10	6.3	6.3	30	30	±30	3
F980J226MMA	М	22	6.3	1.4	20	6	±30	3
F980J336MMA	Μ	33	6.3	4.2	35	8	±30	3
F980J476MMA	Μ	47	6.3	29.6	45	10	±30	3
F980J476MSA	S	47	6.3	3.0	25	6	±30	3
F980J107MMAAXE	Μ	100	6.3	126	80	10	±30	3
F980J107MSA	S	100	6.3	63.0	50	8	±30	3

Rated *2 DF ESR *1 Case Capacitance AVX MSL DCL @ 120Hz ∆C/C Voltage @ 100kHz Part No. Size (µF) (μA) (Ω) (V) (%) (%) 10 Volt ±30 F981A225MMA М 2.2 10 0.5 6 7.5 F981A225MUA U 2.2 10 0.5 15 15 ±30 F981A475MMA М 4. 10 0.5 6 6 ±30 25 20 30 F981A475MUALZT U 4.7 10 4.7 25 ±30 F981A106MMA F981A226MMALZT 1.0 Μ 10 10 ±30 7.5 M 10 11.0 22 ±30 8 F981A226MSA S 22 10 2.2 20 4 ±30 F981A336MMALZT Μ 10 33.0 45 8 ±30 3 S S 33 3.3 30 F981A336MSA 10 ±30 6 F981A476MSA 47 10 9.4 35 5 +3016 Volt F981C474MUA U 0.47 0.5 25 ±20 <u>±30</u> F981C105MMA Μ 10 16 0.5 6 0.5 F981C225MMA М 2.2 16 6 10 ±30 3 F981C475MMA F981C106MSA M S 12 18 ±30 ±30 4.7 16 0.8 12 1.6 16 4 2 20 Volt F981D105MMA M 0.5 6 10 ±30 3 20 25 Volt F981E105MMA M 0.5 10 ±30 8 3 - 2 35 Volt F981V105MSA S 1 35 0.7 20 8 ±30 3

Moisture Sensitivity Level (MSL) is defined according to J-STD-020.

We can consider the type of compliance to AEC-Q200.

are being designed in your application.

Please contact to your local AVX sales office when these series

*2: Leakage Current

After 5 minute's application of rated voltage, leakage current at 20°C.



F98 Series

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QUALIFICATION TABLE

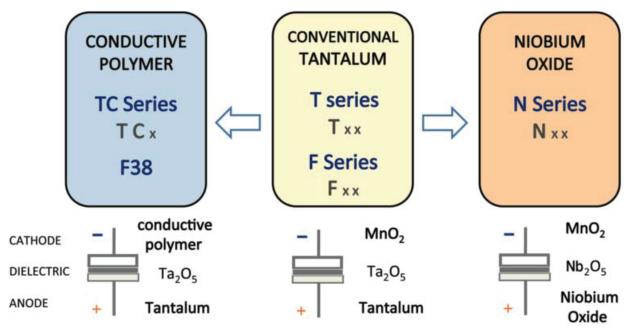
TEST	F98 series (Temperature range -55°C to +125°C)							
1231	Condition							
	At 40°C, 90 to 95% R.H., 500 hours (No voltage applied)							
Damp Heat	Capacitance Change							
(Steady State)	Dissipation Factor 150% or less of initial specified value							
	Leakage Current							
	-55°C / +125°C, 30 minutes each, 5 cycles							
Temperature Cycles	Capacitance Change							
remperature oyoics	Dissipation Factor 150% or less of initial specified value							
	Leakage Current							
Desistance to	10 seconds reflow at 260°C, 5 seconds immersion at 260°C.							
Resistance to	Capacitance Change							
Soldering Heat	Dissipation Factor Initial specified value or less							
	Leakage Current Initial specified value or less							
	After application of surge in series with a $1k\Omega$ resistor at the rate of 30 seconds ON, 30 seconds OFF,							
	for 1000 successive test cycles at 85°C, capacitors shall meet the characteristic requirements in the table above.							
Surge	Capacitance Change							
	Dissipation Factor 150% or less of initial specified value							
	Leakage Current							
	After 1000 hours' application of rated voltage in series with a 3Ω resistor at 85°C,							
	capacitors shall meet the characteristic requirements in the table above.							
Endurance	Capacitance Change							
	Dissipation Factor 150% or less of initial specified value							
	Leakage Current 200% or less of initial specified value							
Choor Toot	After applying the pressure load of 5N for 10±1 seconds horizontally to the center of capacitor side body 👝 😐 🖛							
Shear Test	which has no electrode and has been soldered beforehand on a substrate, there shall be found neither							
	exfoliation nor its sign at the terminal electrode.							
	Keeping a capacitor surface-mounted on a substrate upside down and supporting the substrate at both of the opposite bottom points 45mm apart from the center of capacitor, the pressure strength is $\frac{1220}{2}$							
Terminal Strength								
	applied with a specified jig at the center of substrate so that the substrate may bend by 1mm as							
	illustrated. Then, there shall be found no remarkable abnormality on the capacitor terminals. $ \frac{1}{4^{-19}+ \frac{4^{-19}}{4^{-19}+ \frac{4^{-19}}{4^{-$							

F98 Series

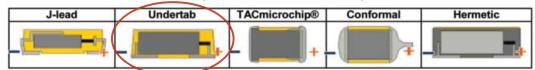


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AVX SOLID ELECTROLYTIC CAPACITOR ROADMAP



Five Capacitor Construction Styles



SERIES LINE UP: CONVENTIONAL SMD MnO₂

